TXC CORPORATION
4F, NO. 16, Sec. 2 Chung Yang S Rd., Peitou, Taipei, Taiwan.
TEL : 886-2-2894-1202 , 886-2-2895-2201 FAX : 886-2-2894-1206 , 886-2-2895-6207 www.txccorp.com

SPECIFICATION FOR APPROVAL

CUSTOMER	:	
PRODUCT TYPE	:	HC-49/S SMD
NOMINAL FREQ.	:	25.000000MHz
TXC P/N	:	9C25000499
REVISION	:	A3
CUSTOMER P/N	:	
PM / SALES	:	
DATE	:	

CUSTOMER SIGNATURE & Date

(1) TXC requires one copy returned with signature and title of authorized individual that signifies acceptance of the attached specifications.

(2) Orders received and accepted by TXC after return of signed copy of specification will be produced per these specifications.

(3) Any changes to these specifications must be agreed upon by both parties and new revision of the Product Specification Sheet will be issued.

(4) Any issuance of purchase order prior to consigning back the Approval page of "Specification Sheets" from customers will be regarded as the agreement on the contents of these specifications.

Attachment: Product Specification Sheet

1
2
3
4
5

RoHS Compliant

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PRODUCT SPECIFICATION SHEET

PRODUCT TYPE	:	HC-49/S SMD
NOMINAL FREQ.	:	25.000000MHz
TXC P/N	:	9C25000499
REVISION	:	A3

PE/RD	QA	MFG
Simon Wang	Tom Hsieh	Shu-Chen Ko
2013/7/5	*2013/7/5*	*2013/7/5*

NOTE:

(1)Lead Free Products are "Directive 2002/95/EC of The European Parliament of 27 January 2003 on the restriction of the use of certain hazardous substances (RoHS) in electrical and electronic equipment" Compliant (Attachment: SGS Test Report).

(2)Revision "Sx" is for engineering samples only. PE/RD's approval required.

(3)Revision "Ax" is production ready. PE, QA and MFG's approval required

RoHS Compliant

Rev	Revise page	Revise contents	Date	Ref.No.	Reviser
A1	N/A	Initial Released	2011/3/10	N/A	Shu-Chen Ko
A2	7	Reel Size Change	2011/4/7	ECR-11A031101	Shu-Chen Ko
A3	4,7,9,10	Form Change(Page 4,Page 9, Add Page 7,Page 10).	2012/12/17	ECR-12A112101	Shu-Chen Ko

CONTENT

SPECIFICATIONS	PAGE
• ELECTRICAL SPECIFICATIONS	4
• DIMENSIONS	5
• SUGGESTED REFLOW PROFILE	5
• SUGGESTED MANUAL SOLDER CONDITION	5
• MARKING	6
• STRUCTURE ILLUSTRATION :	7
• EMBOSS CARRIER TAPE & REEL	8
• PACKING	8
• RELIABILITY SPECIFICATIONS	9 , 10

ATTACHMENT(S) (optional)

TESTING DATA

- ELECTRICAL CHARACTERISTICS TEST — A ☐ YES ☑ NO
- TEMPERATURE CHARACTERISTICS TEST — B ☐ YES ☑ NO

ELECTRICAL SPECIFICATIONS

Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurement and tests are as follow:

Ambient temperature : 25+/-5°C

Relative humidity : 40%~70%

If there is any doubt about the results, measurement shall be made within the following limits:

Ambient temperature : 25+/-1°C

Relative humidity : 40%~70%

Measure equipment

SAUNDERS 250A/250B CRYSTAL IMPEDANCE METER.

Crystal cutting type

The crystal is using AT CUT (thickness shear mode).

Unit Weight : 0.58 g +/- 0.05g



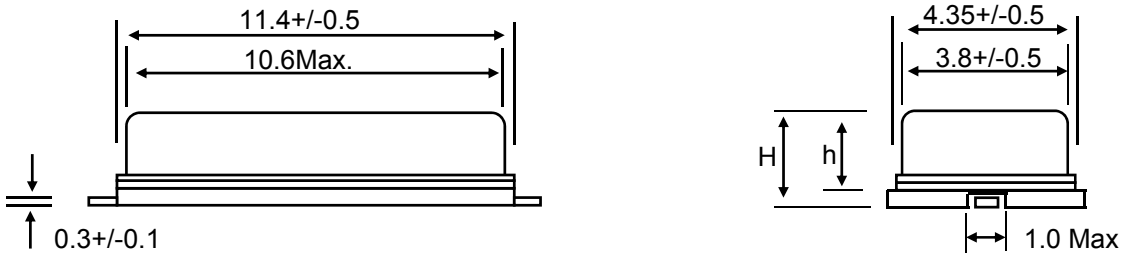
please refer to marking code page

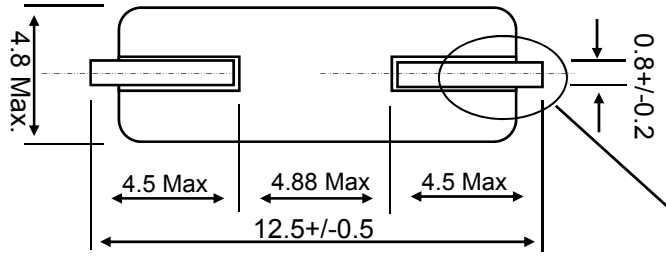
	Parameters	SYM	Electrical				Notes
			MIN.	TYP.	MAX.	UNITS	
1	Nominal Frequency	FL	25.000000 MHz			MHz	
2	Oscillation Mode		Fundamental				
3	Load Capacitance	CL		30.0		pF	
4	Frequency Tolerance	FT	-30		+30	ppm	at 25 °C +/- 3 °C
5	Frequency Tolerance	ST	-30		+30	ppm	Over Operating Temp.Range
6	Operating Temperature	OT	-40		+85	°C	
7	Aging		-5		+5	ppm	1st year
8	Drive level	DL		100	500	uW	
9	Effective Resistance Rr	Rr			40	ohm	
10	Shunt Capacitance	C0			7	pF	
11	Motional Capactiance	C1				fF	
12	Insulation Resisstance		500			Mohm	at DC 100V
13	Storage Tempeature Range		-40		+85	°C	
14	SPDB(+/-5000ppm)				-3.0	dB	

■ FACTORY LOCATION : CHINA

DIMENSIONS

UNIT:mm

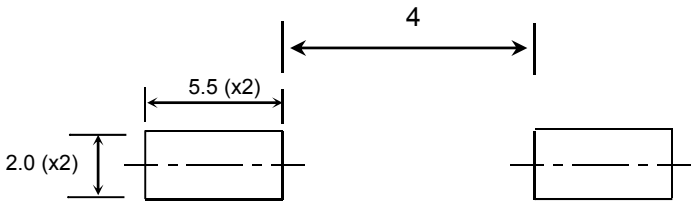




CHOOSE	TYPE	H(SMDHIGH)	h(BODY HIGH)
■	S3	3.8+/-0.3	3.3+/-0.3
□	S2	3.0+/-0.3	2.3+/-0.3

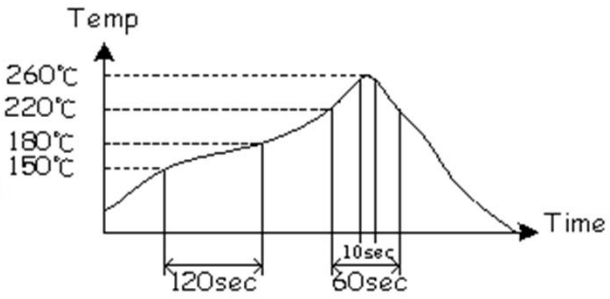
Solder Coating
(Sn-Ag-Cu Pb Free Coating)

Suggested Layout



■ SUGGESTED REFLOW PROFILE

Solder melting point :220+/-10 °C, 60 sec. Min.
Peak Temperature: 260 +/- 5 °C, 10 sec. Max.

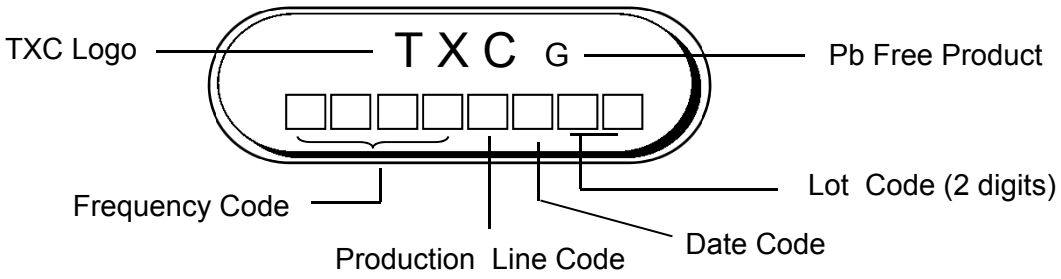


■ SUGGESTED MANUAL SOLDER CONDITI

Temperature: 350 +/- 10 °C
Time: 3 sec.
Re-solder times: twice

MARKING

Marking For Pb Free Parts：



Date Code:

YEAR \ MONTH					JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC
2013	2017	2021	2025	2029	A	B	C	D	E	F	G	H	J	K	L	M
2014	2018	2022	2026	2030	N	P	Q	R	S	T	U	V	W	X	Y	Z
2015	2019	2023	2027	2031	a	b	c	d	e	f	g	h	j	k	l	m
2016	2020	2024	2028	2032	n	p	q	r	s	t	u	v	w	x	y	z

*This date code will be cycled every four years.

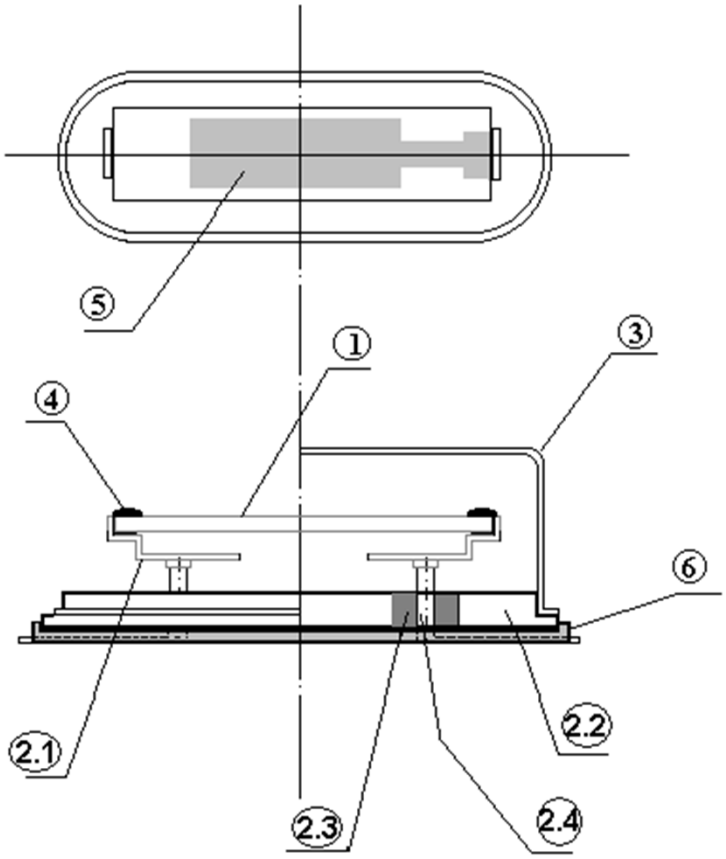
For example： Marking



→

Introduction： Pb Free Product
49S 25.000 MHz
Made in NGB 2013/JAN 01Lot

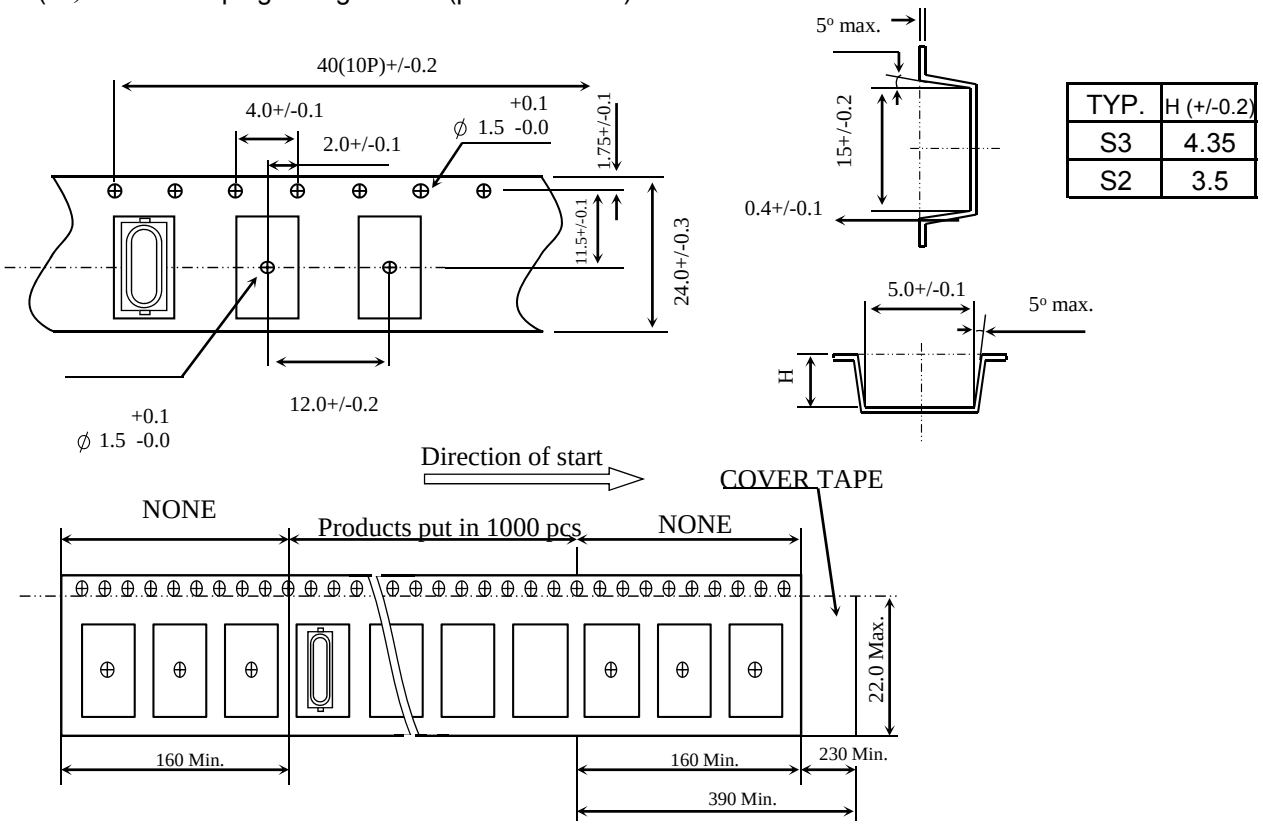
STRUCTURE ILLUSTRATION :



NO		COMPONENTS		MATERIALS	FINISH/SPECIFICATIONS
1		CRYSTAL BLANK		QUARTZ (SiO_2)	/
2	2.1	CRYSTAL BASE	SUPPORTER	NICKEL SILVER	/
	2.2		HOLDER	SPCC	Ni PLATED
	2.3		GLASS	GLASS	/
	2.4		LEAD	KOVAR	Ni PLATED+SOLDER DIPPED (Coating : Sn/Ag/Cu)
3		CRYSTAL COVER		NICKEL SILVER	Ni PLATED
4		CONDUCTIVE ADHESIVE		Ag + RESIN	/
5		ELECTRODE		Noble Metal	/
6		INSULATION PAD		PPS	/

(A) Tape and reel configuration:(Unit：mm)

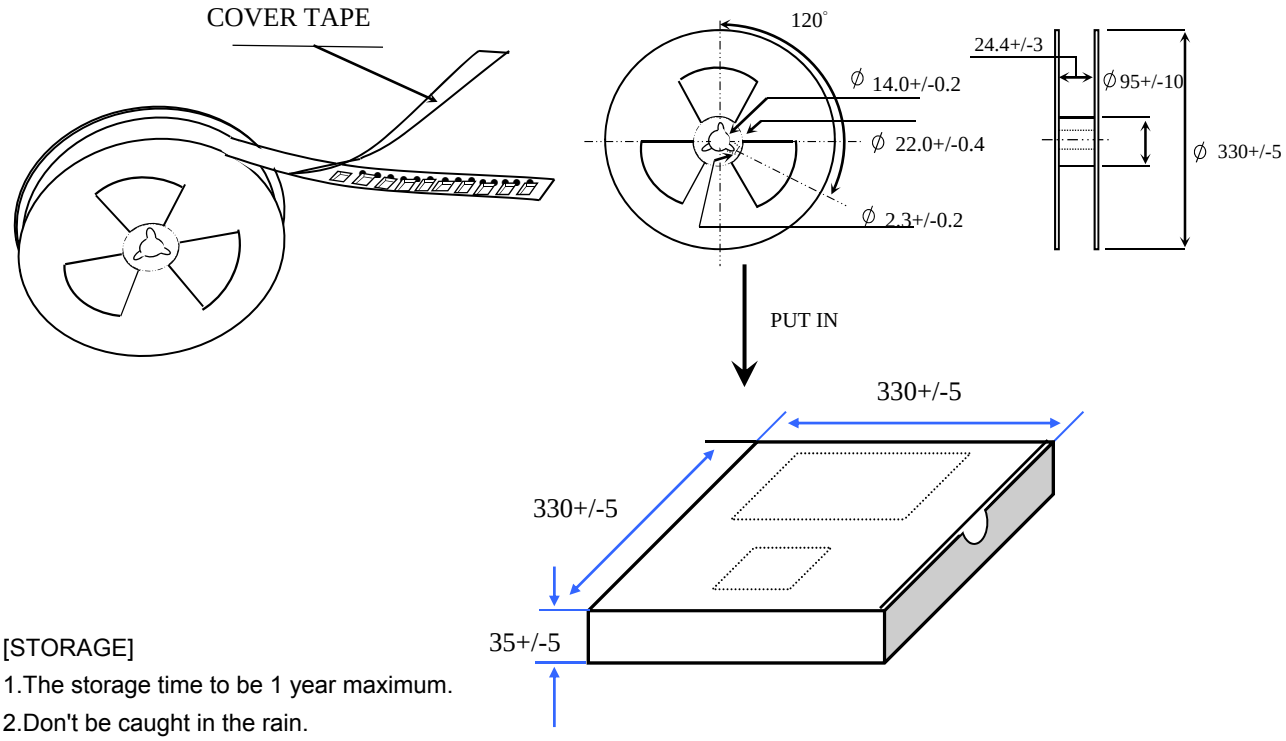
(a) Emboss taping configuration. (per EIA-481-2)



TYP.	H (+/-0.2)
S3	4.35
S2	3.5

(b) Reel configuration.

(B) Packing & Label :(Unit：mm)



[STORAGE]

1.The storage time to be 1 year maximum.

2.Don't be caught in the rain.

3.The storage environment shall be 5°C ~40°C temperature and 30% ~ 75%RH humidity and free from the sun shine.

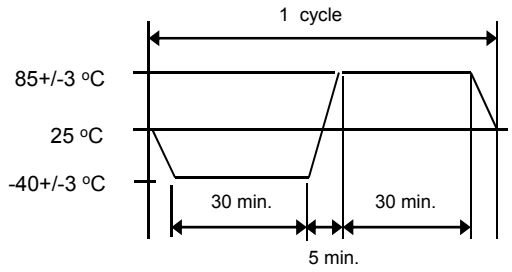
4.If customers have special requirements, we can paste labels according to it.

■ RELIABILITY SPECIFICATIONS

1.Mechanical Endurance

No.	Test Item	Test Methods	Test Criteria
1.1	Drop test	50 cm Height, Fall freely onto firm wood for 3 times.	B C
1.2	Mechanical Shock	1000 G , 0.5 m Sec. , 3 times for all 3 directions.	B C
1.3	Vibration	Frequency range 10 ~ 2000 Hz Acceleration 5G Sweep time 20 minute Pendicular axes each test time 4 hours (Total test time 12 hours)	B C
1.4	Terminal Strength	17.7N force for 60sec +/-1sec.	F
1.5	Solderability	Pb free :Temperature 235+/-5°C,Immersion time:5+/-1sec Pb :Temperature 215+/-5°C,Immersion time:5+/-1sec	E

2.Environmental Endurance

No.	Test Item	Test Methods	SPEC
2.1	Resistance To Soldering Heat	Test temperature 260 +/- 5 °C Test time 10 +/- 1 sec. Emersion Rate 25 +/- 6 mm/s Immersed of specimen 1.5mm	ACD
2.2	High Temp. Storage	+ 85°C +/- 3 °C for 500 +/- 12 Hrs	ACD
2.3	Low Temp. Storage	- 40 °C +/- 3 °C for 500 +/-12 Hrs	ACD
2.4	Temperature cycle	-40°C~85°C,for 300 cycles. 	ACD
2.5	High Temp＆Humidity	85°C +/- 3°C , RH 85% , 500 Hrs	ACD

■HANDING CAUTIONS

Prohibit the use of ultrasonic welding in Assemblying

RELIABILITY SPECIFICATIONS

Specifications	
A	Frequency change: Within +/-20ppm or in customer's specification.
B	Frequency change: Within +/-10ppm or in customer's specification.
C	Equivalent series resistance(E.S.R) change: Within +/-15% or 10Ω(larger value).
D	After conditioning , quartz crystal units shall be subjected to standard atmospheric conditions for 24 hour, and measured.
E	Minimum 95% of immersed terminal shall be covered with new uniform solder.
F	No damage on specimen

Measurement condition

Measurements are carried out with Network-analyzer(S&A 250B or equivalent).